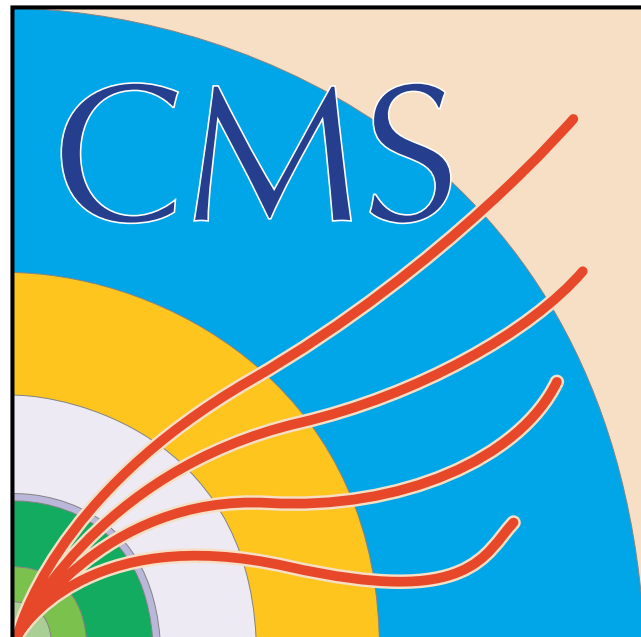


Novel Engineering Techniques



Andreas Mussgiller
for WP *Novel Engineering Techniques*,
Advanced Material and Interconnects

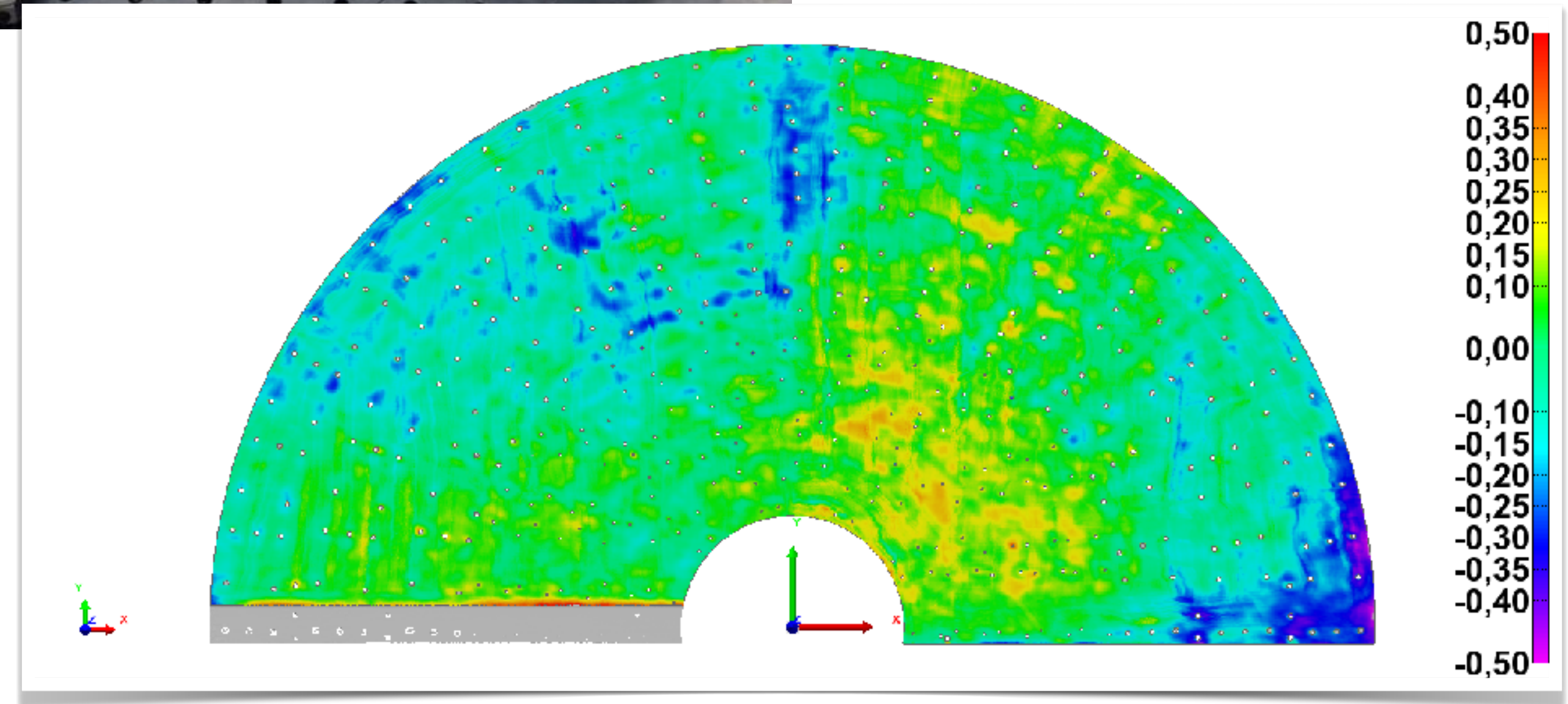
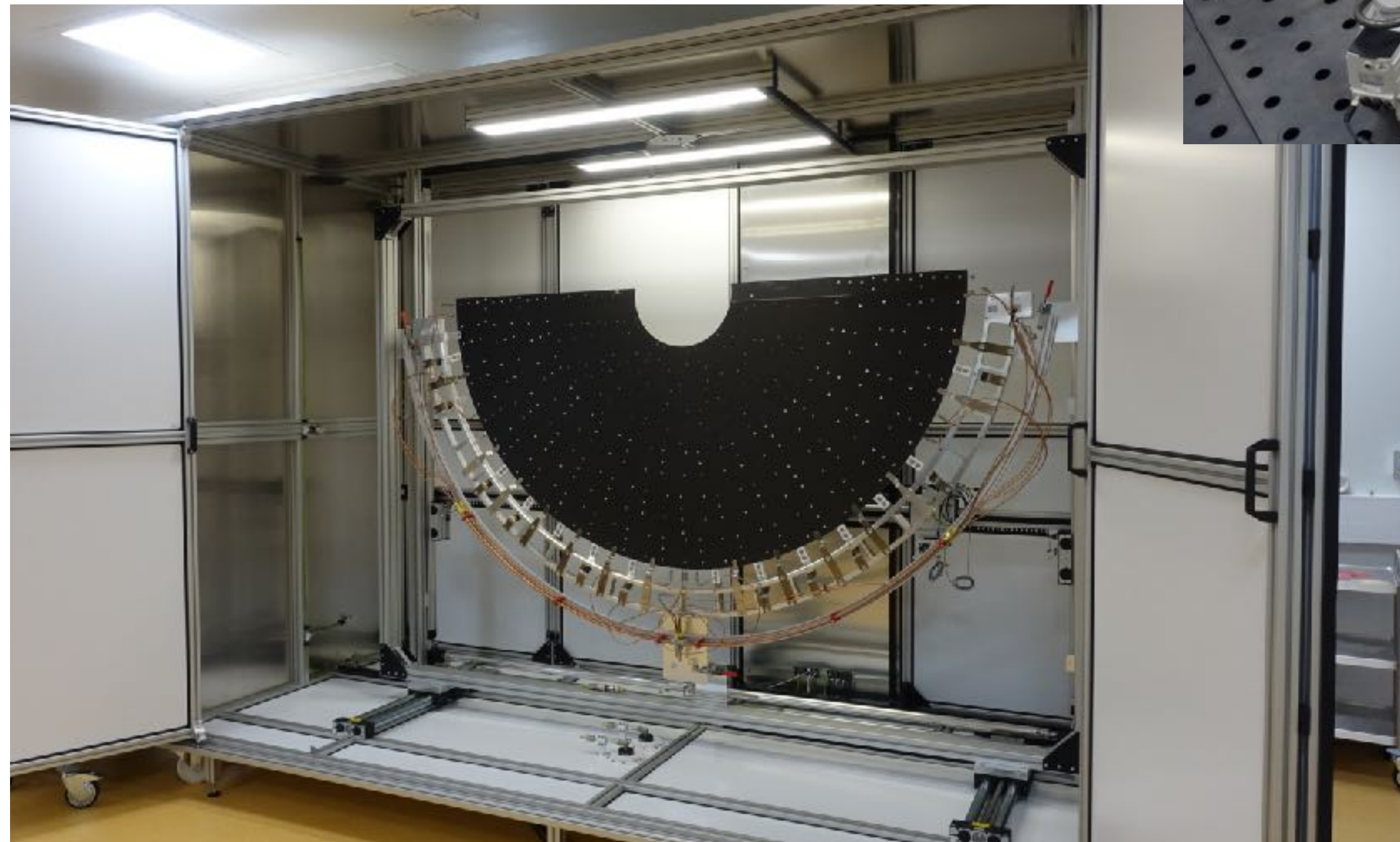
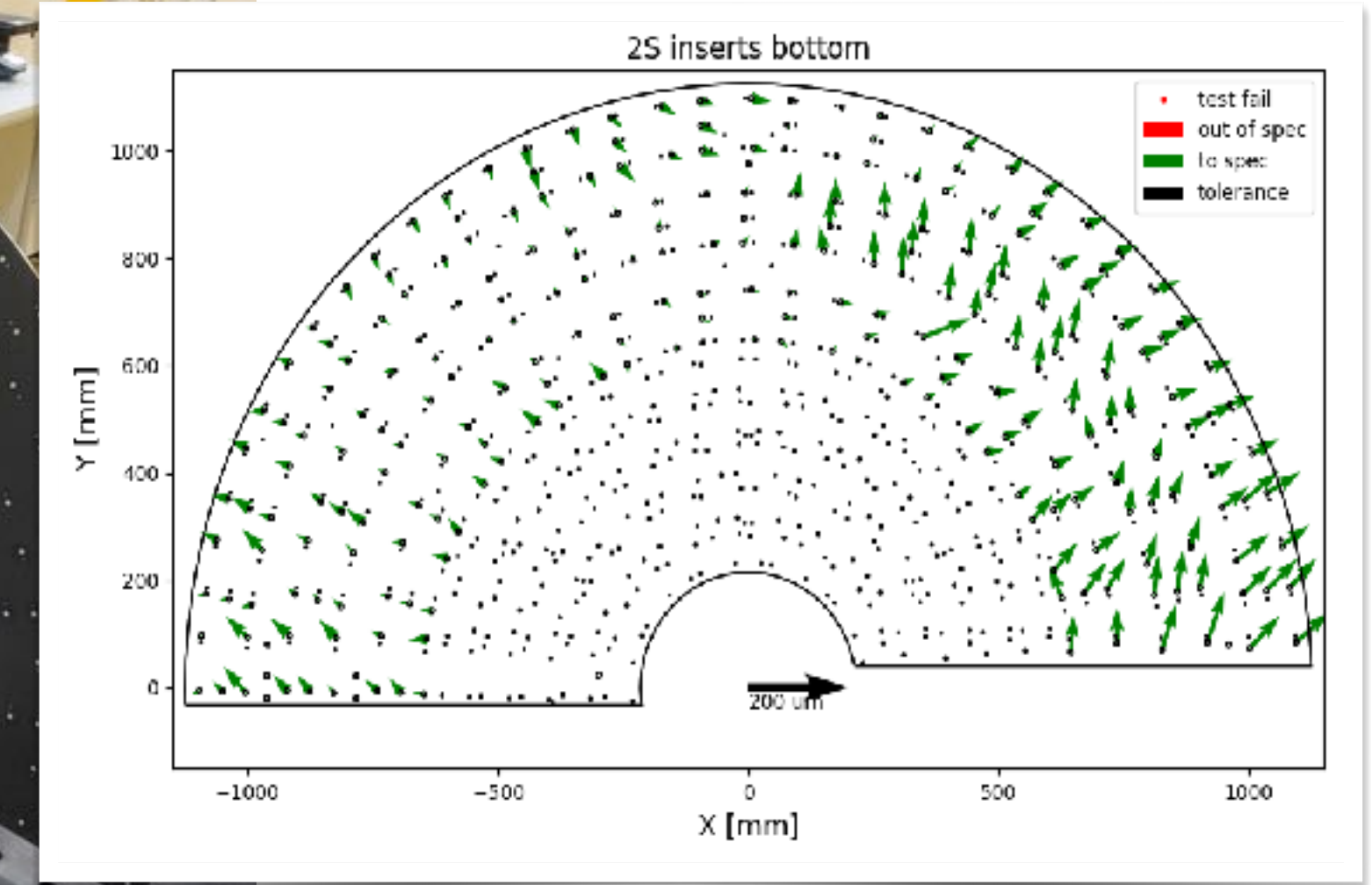
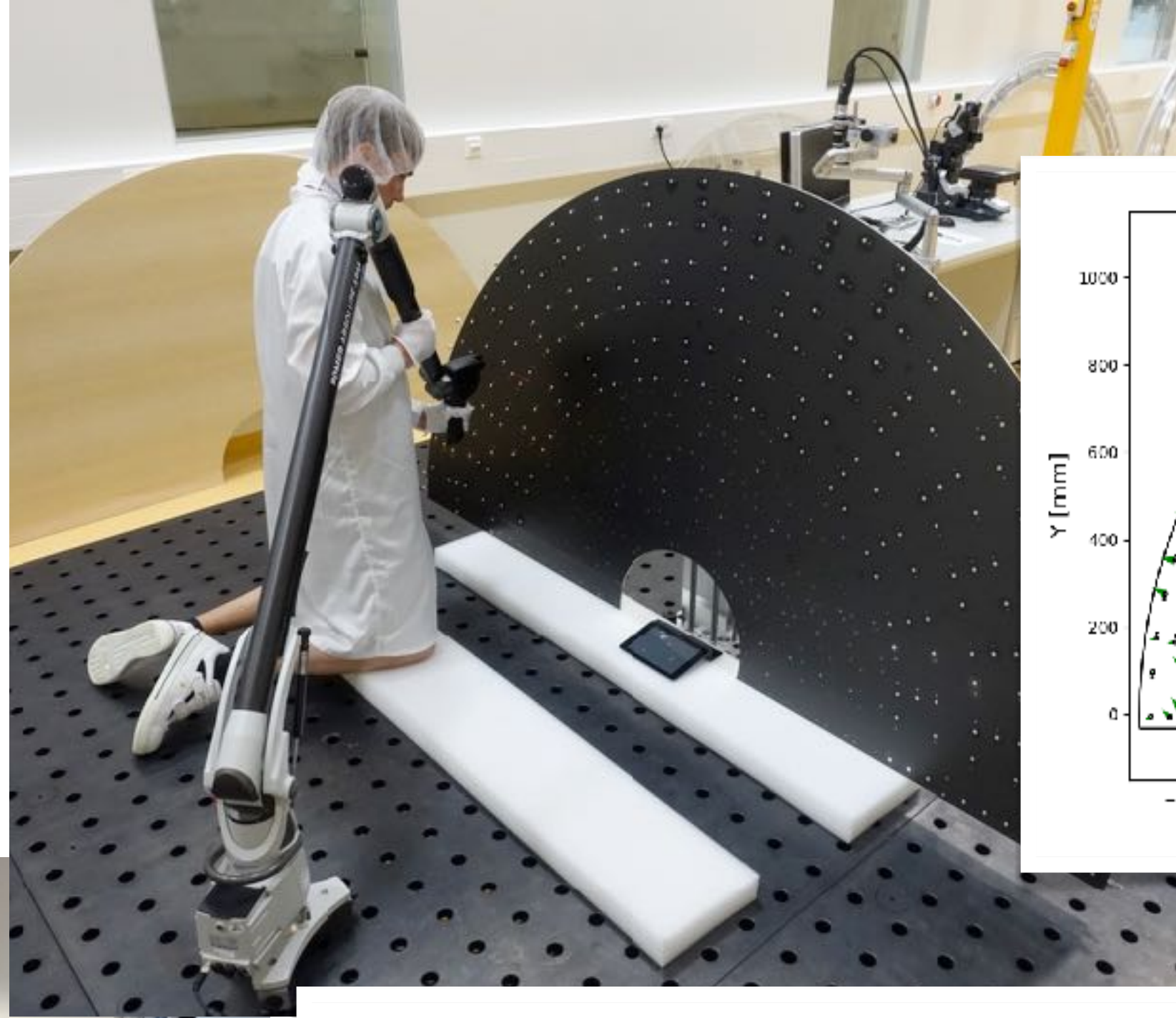
16/12/2020

with material from *DESY FS-DS*,
DESY ATLAS and *DESY CMS*

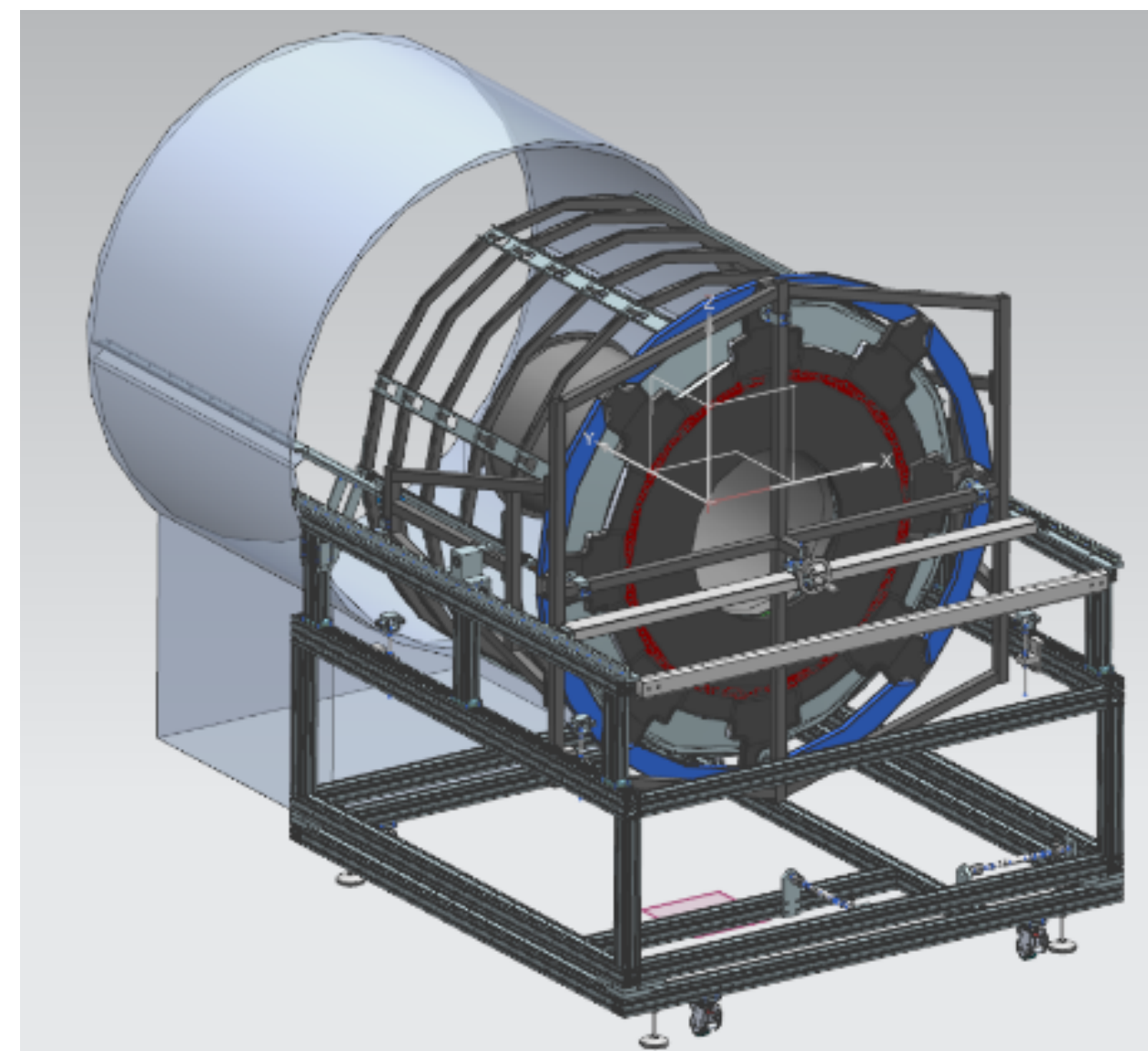
Local Support Structures

CMS Full-Sized Dee Prototype

- First prototype Dee manufactured in industry and delivered earlier this year
- Extensively tested in the past month
 - metrology and laser scans
 - insert positions mostly within specs
 - flatness within specifications
 - thermal testing (IR) will be next



Integration Tooling

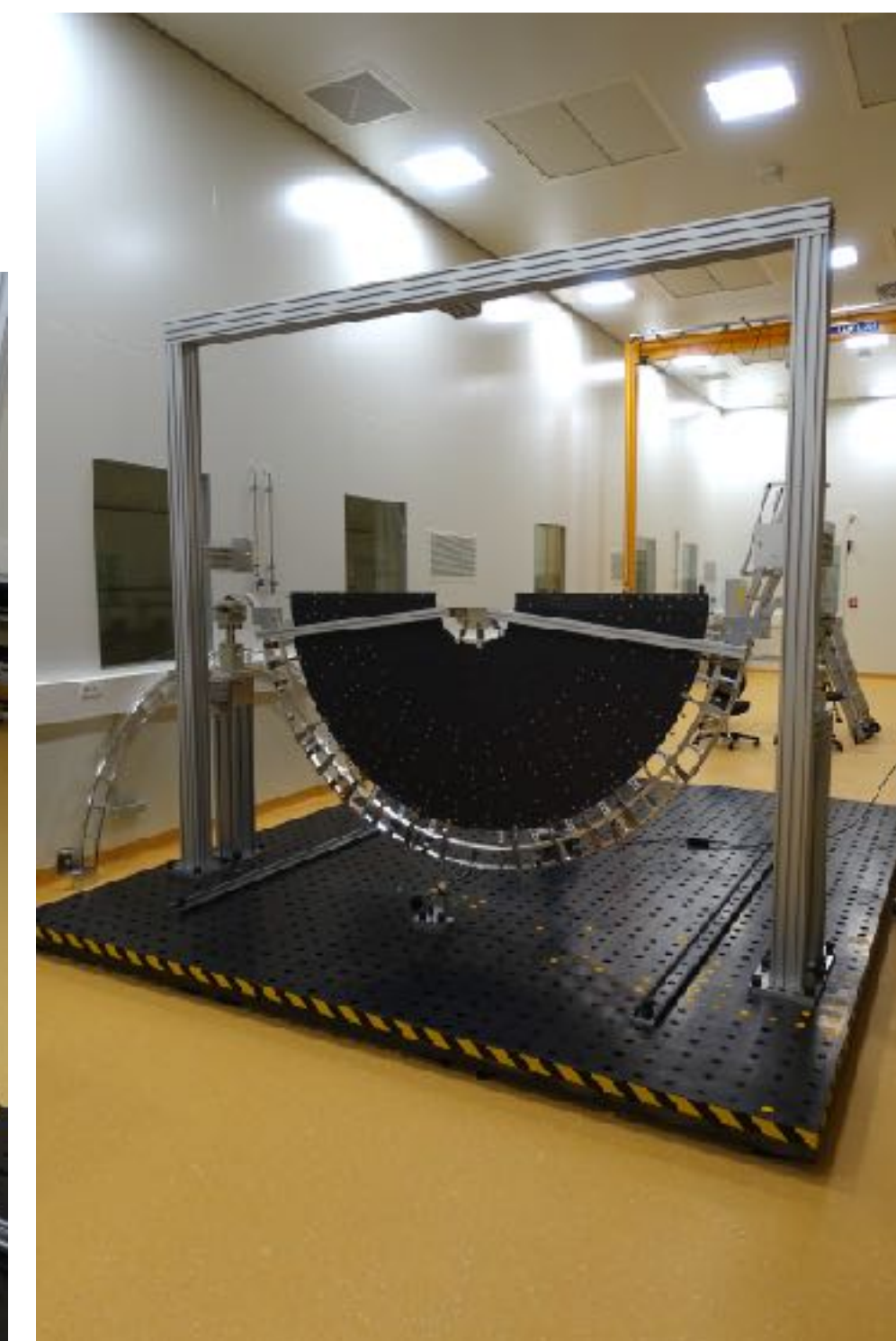
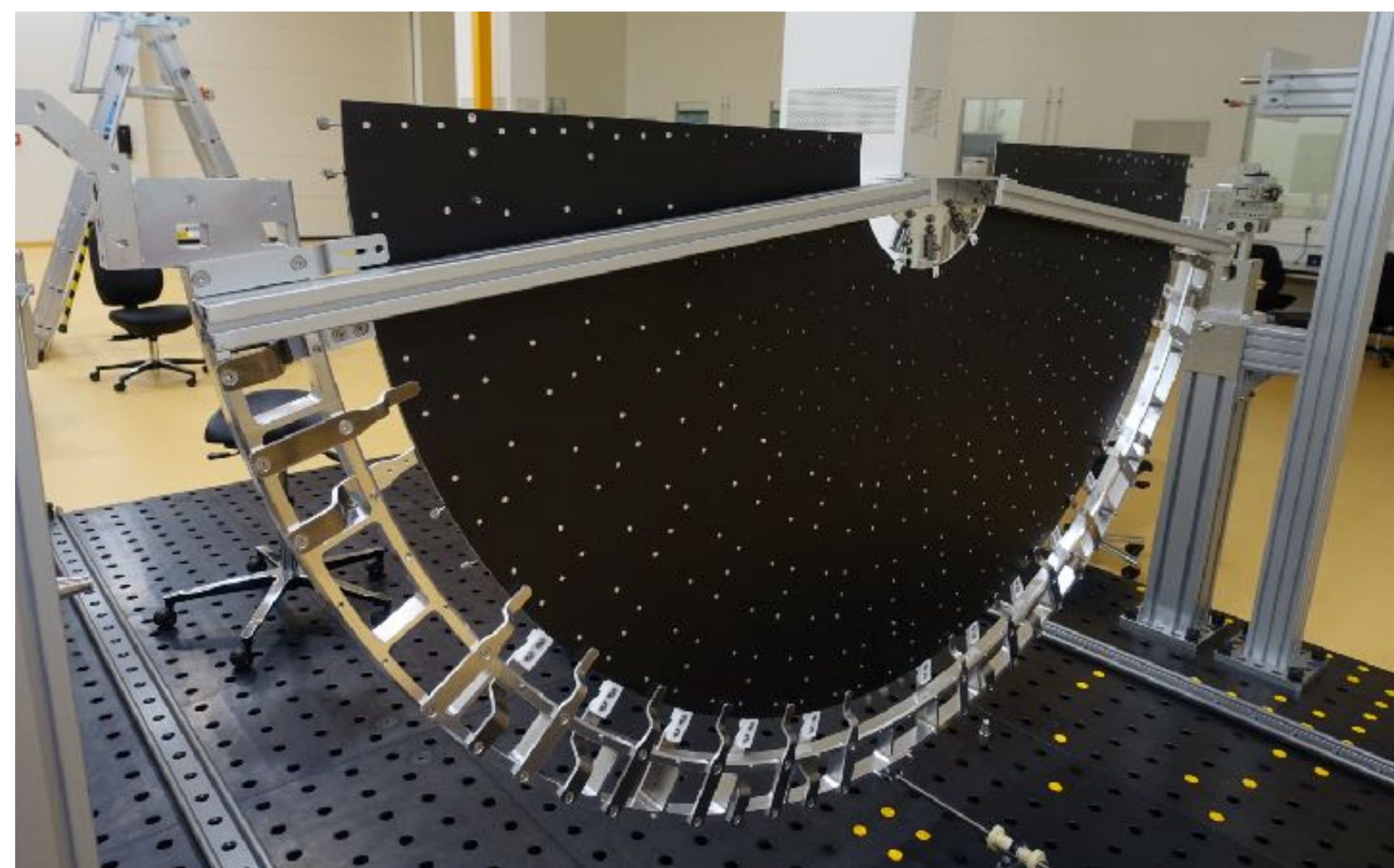


ATLAS Strips Endcap Integration Tooling

- Design and construction of precision tooling for Endcap integration activities
 - insertion of petals into global structure
 - transport and rotation of endcap structure
 - insertion of endcap in ITk Outer Cylinder

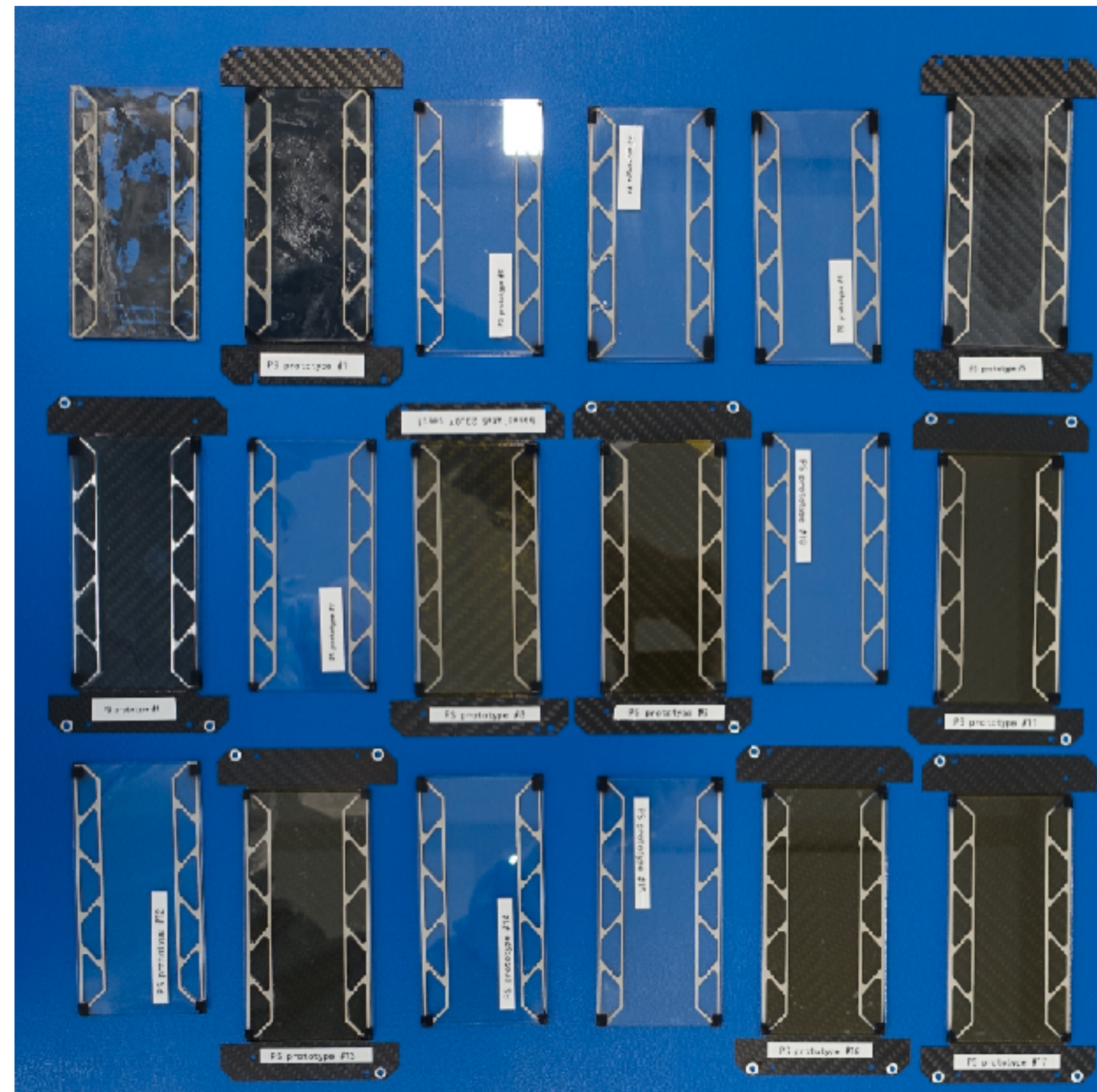
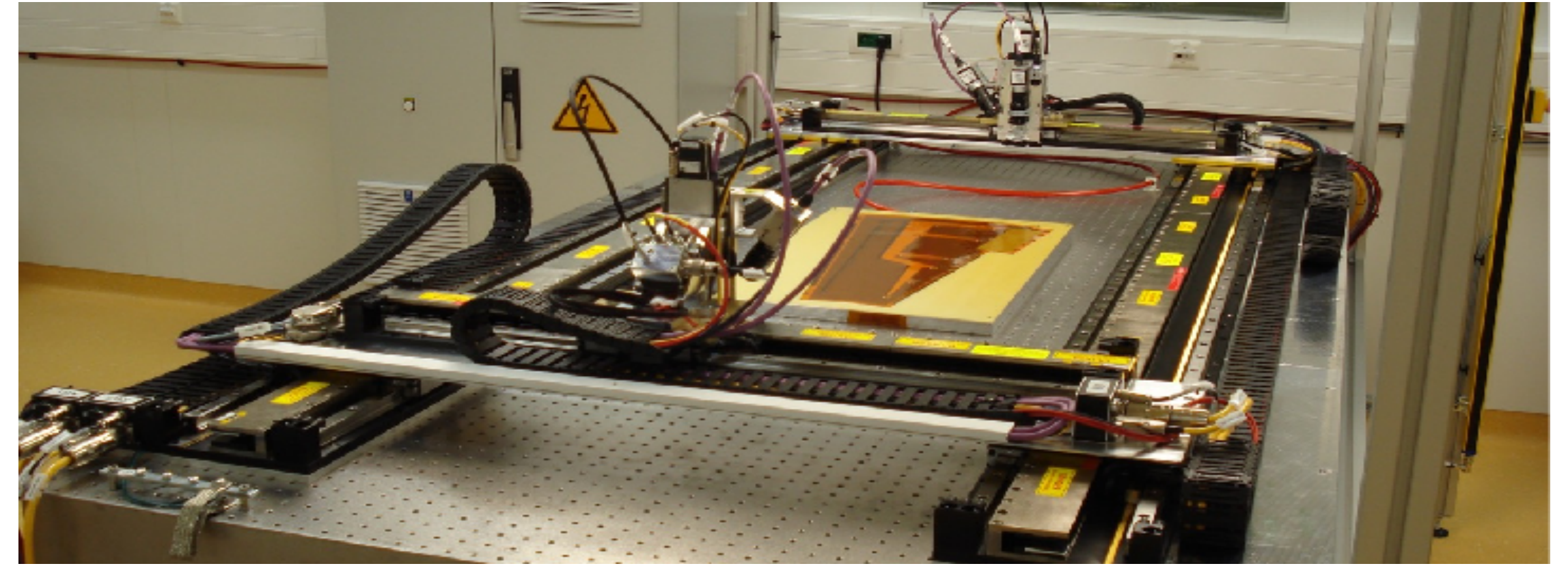
CMS TEDD Integration

- Tooling for
 - Disk assembly (Dee to Dee)
 - Double-Disk assembly (Disk to Disk)
- Will be tested with dummy Dees made of plexiglass as next step
- Real integration tests with prototype Dees delayed due to pandemic
 - One prototype Dee from DESY and one from Lyon



ATLAS Bus Tape Testing Robot

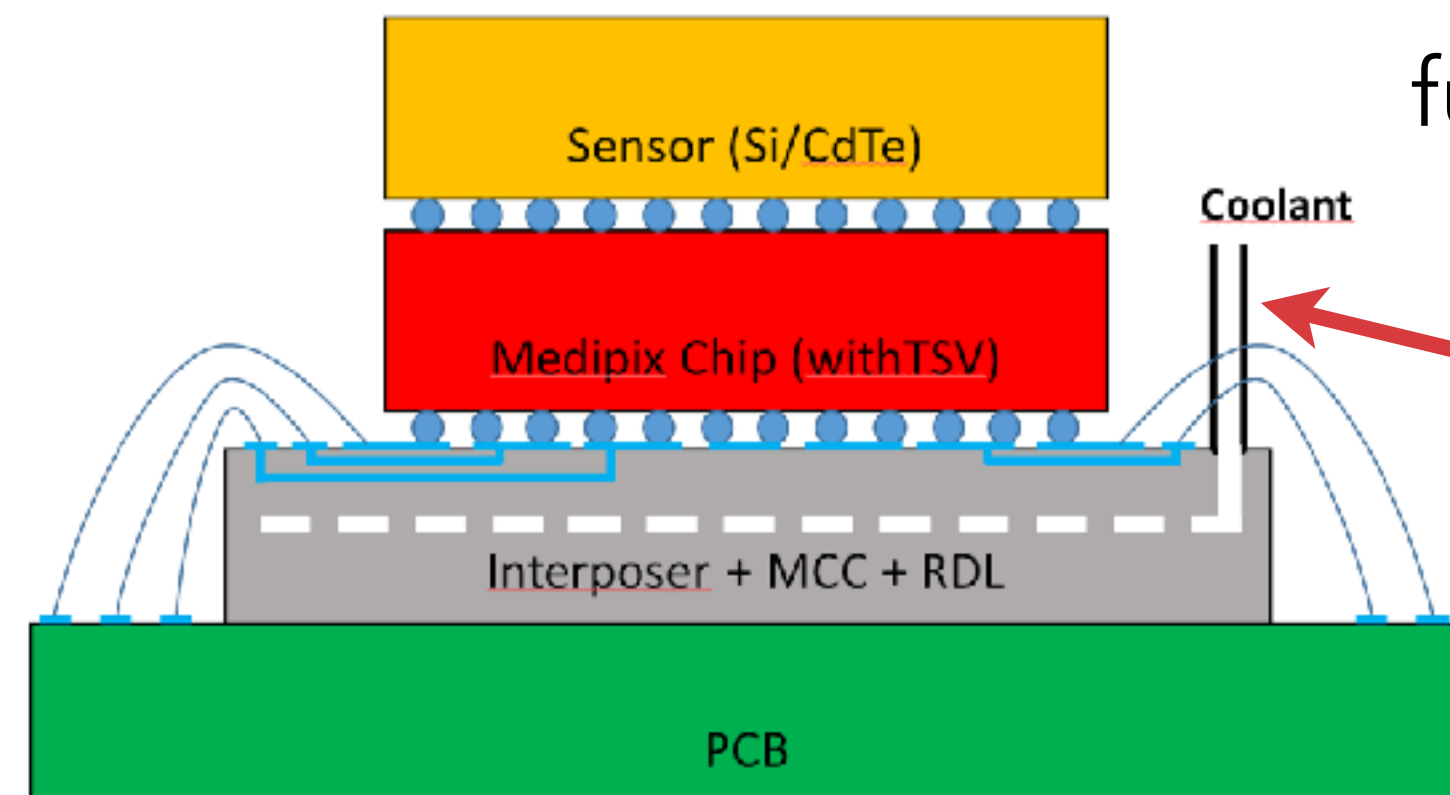
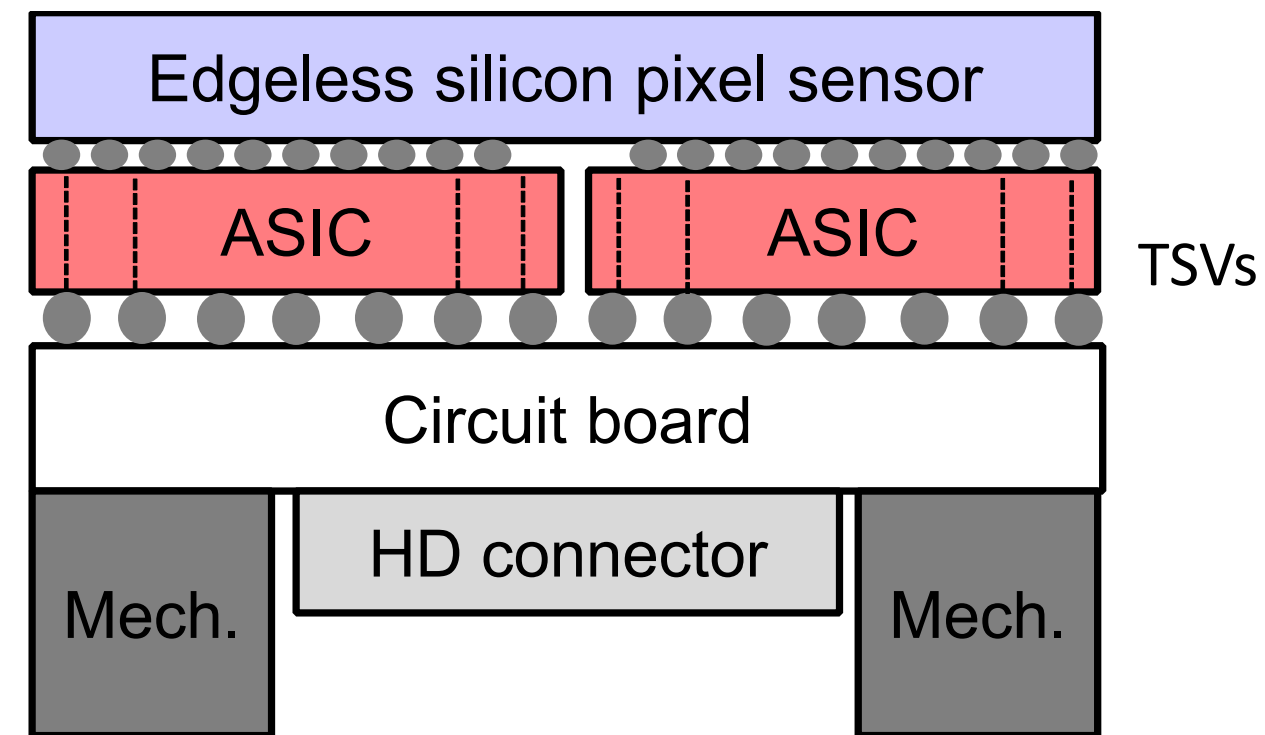
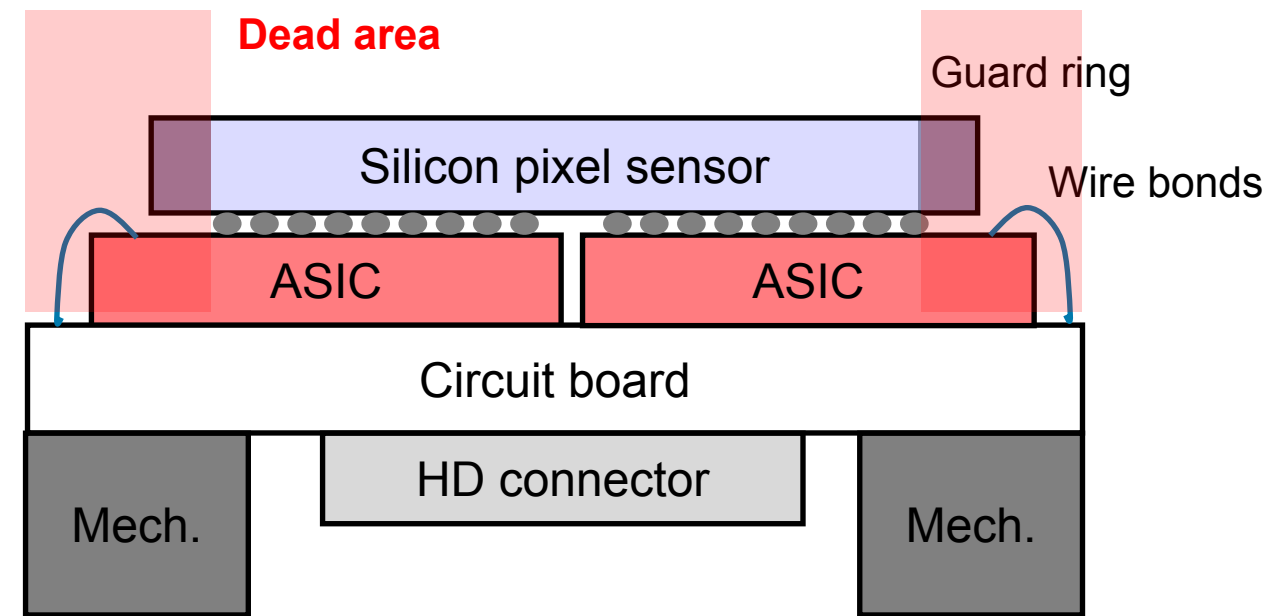
- In-house manufacture of setup for the electrical testing of petal bus tapes
- Two synchronous X-Y-Z stage systems fully automated
 - allows for high-speed differential measurements



CMS PS Module Automated Assembly

- Precision assembly of pT trigger modules
- Based on X-Y-Z stage, vision and vacuum systems
- O(20) dummy modules built to specifications
- Process optimized to reach target throughput of four modules per day
- Setup is in the meantime also used at Brown U and FNAL

Micro Channel Cooling for Photon Detectors



- Motivation
 - reduce the complexity
 - more robust systems
 - reduce the dead areas by using TSVs
- Micro channel cooling demonstrator based on silicon interposer with
 - redistribution layer (RDL) and
 - integrated micro channels (MCC)
- Collaboration agreement/contract with CNM Barcelona signed for production of prototypes
- Connectivity solved for conventional fluid
 - reliability needs to be improved
- Interest from HEP to improve connectivity further to allow use with CO2 cooling

